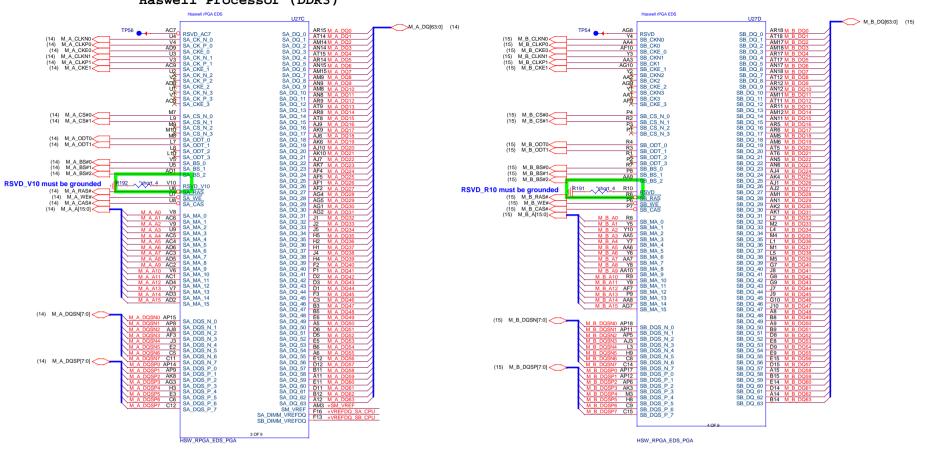
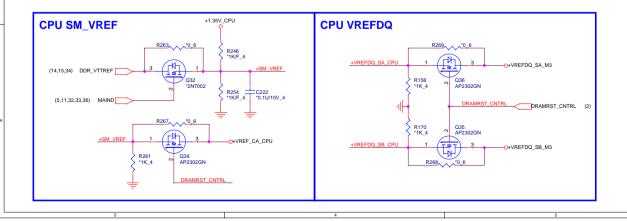


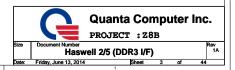
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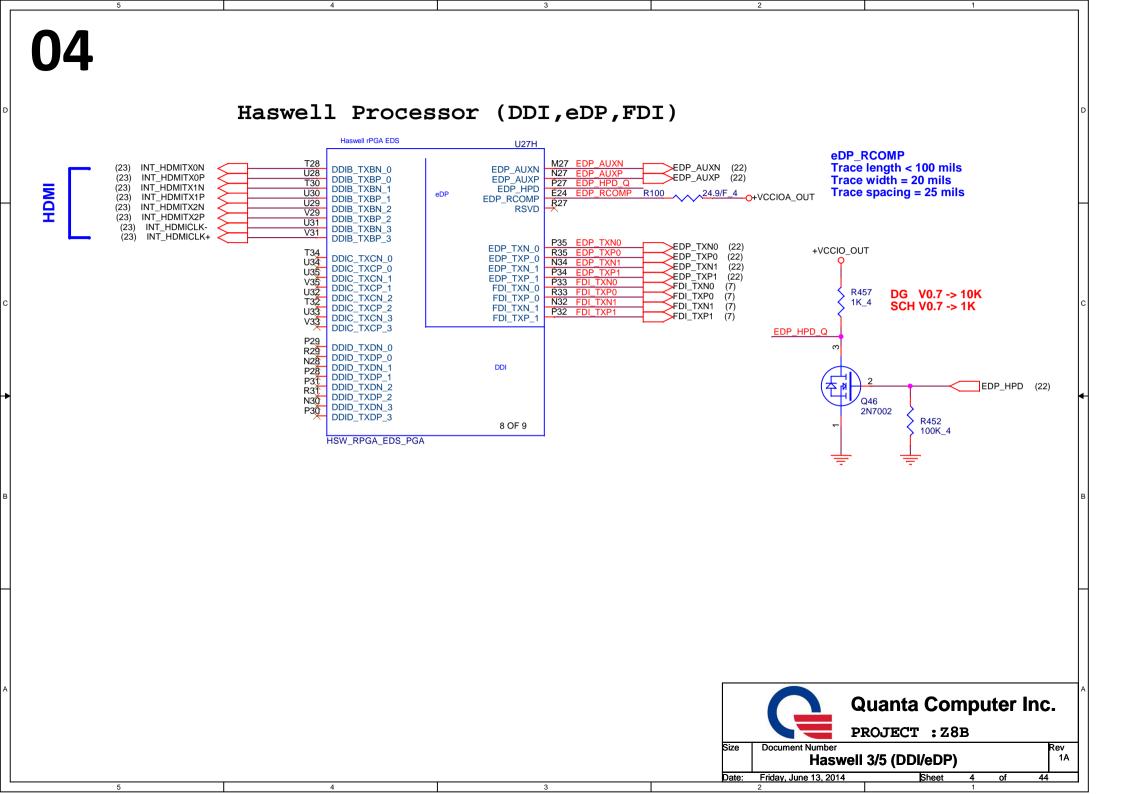
## Haswell Processor (DDR3)

## Haswell Processor (DDR3)





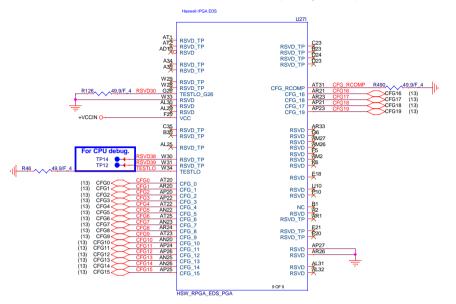




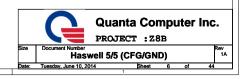
### Haswell Processor (GND)

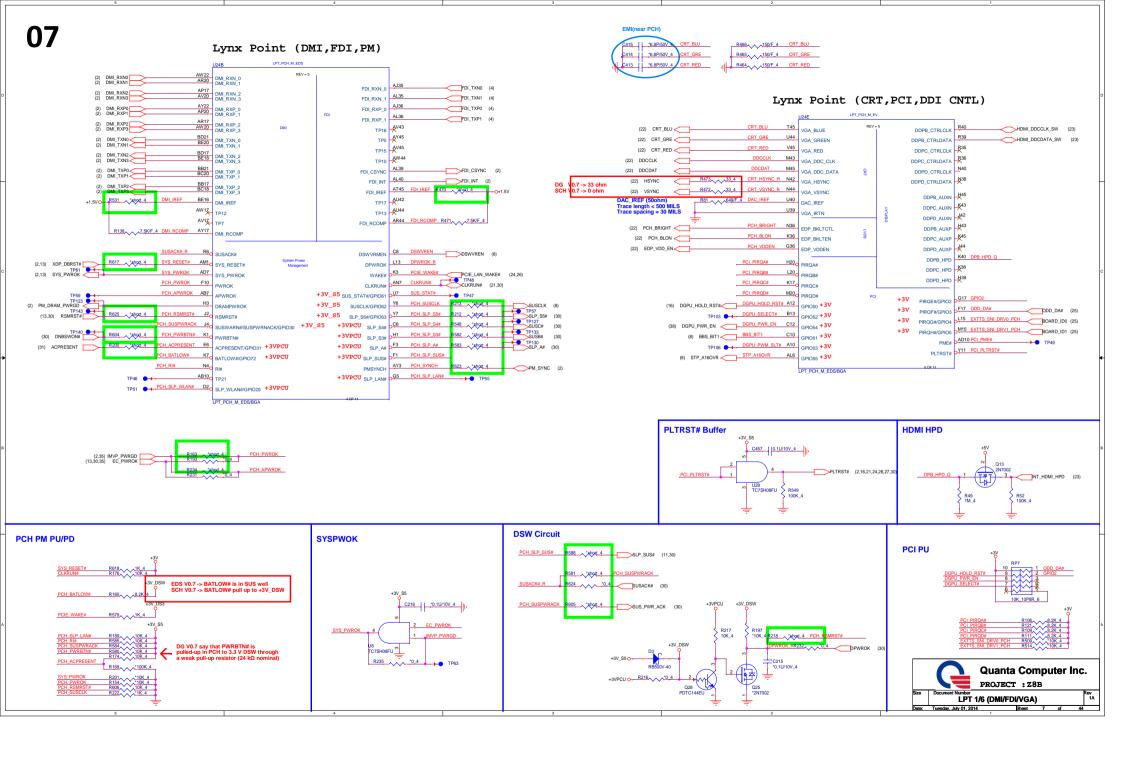


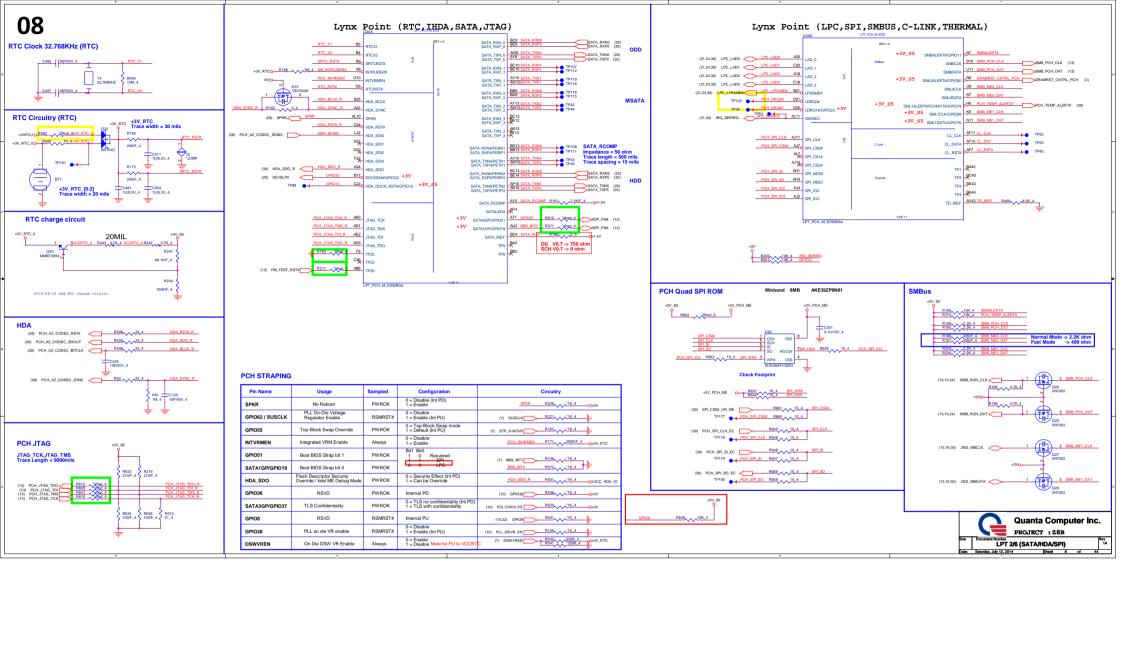
## Haswell Processor (CFG,RSVD)

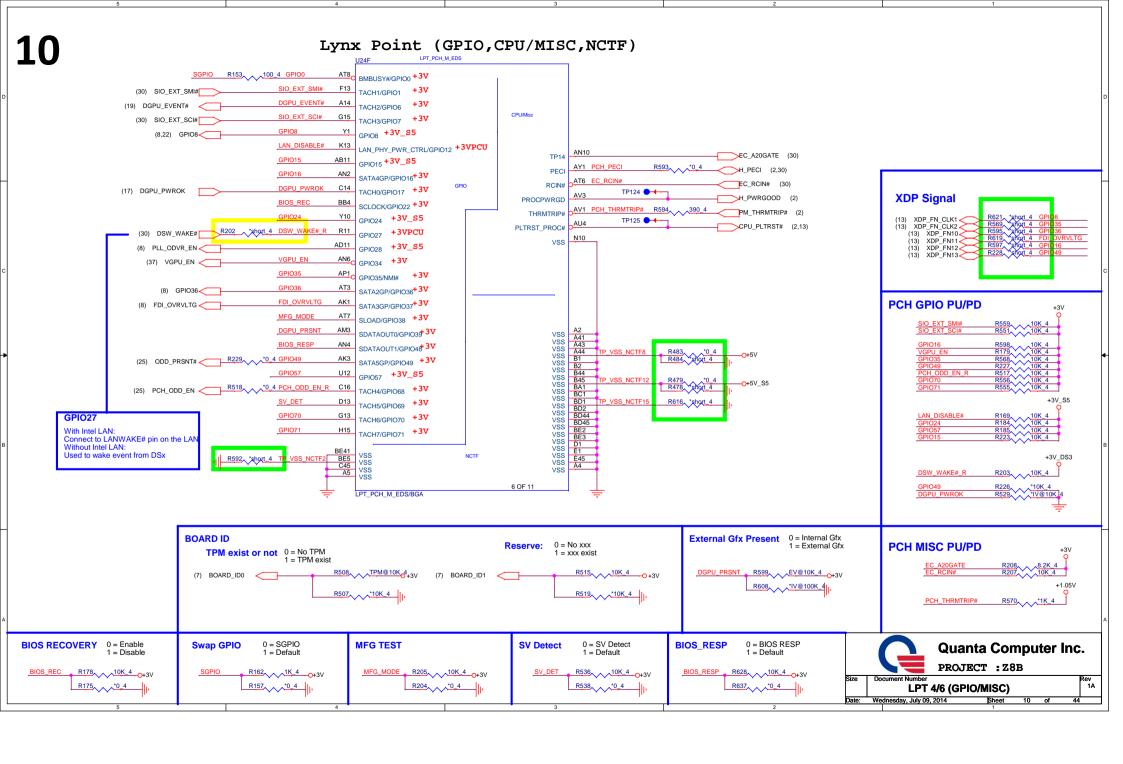


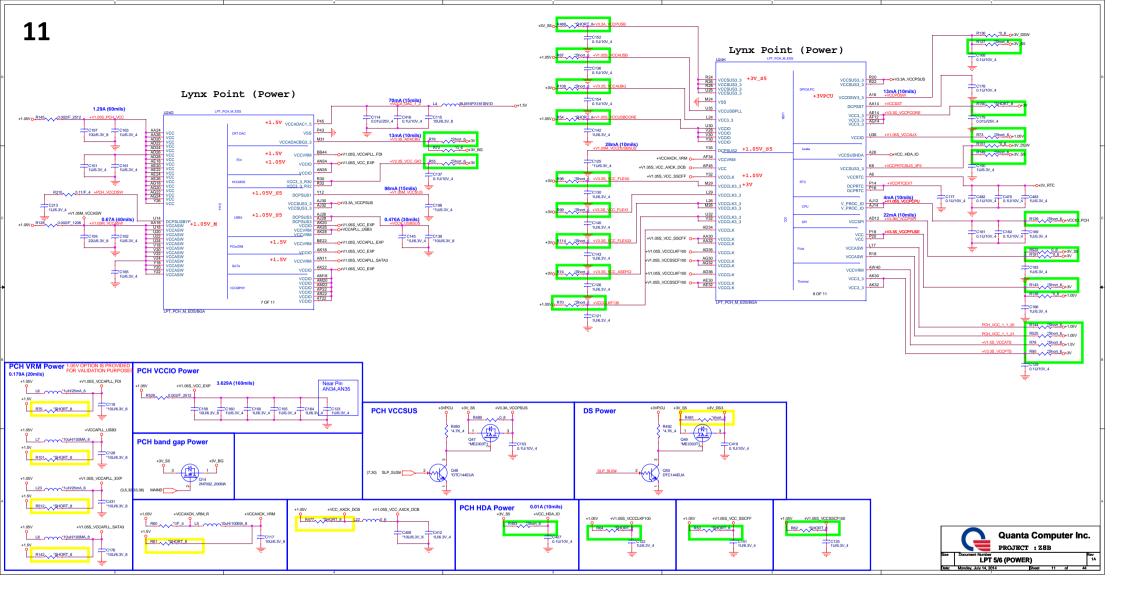
	Configuration Signals:	The CFG signals have a default value of '1' if not terminated on the board.		
CFG[2]	PCI Express Static Lane Reversal	x1 = Normal operation x0 = Lane numbers reversed		
CFG[4]	eDP enable	x1 = Disabled x0 = Enabled		
CFG[6:5]	PCI Express Bifurcation	x00 = 1 x8 & 2 x4 PCI Express x01 = reserved x10 = 2 x8 PCI Express x11 = 1 x16 PCI Express	CFG6 R115 11K 4 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	
CFG[7]	PEG defer training	x1 = PEG train follow RESETB de-asseted x0 = PEG wait for BIOS fro training		

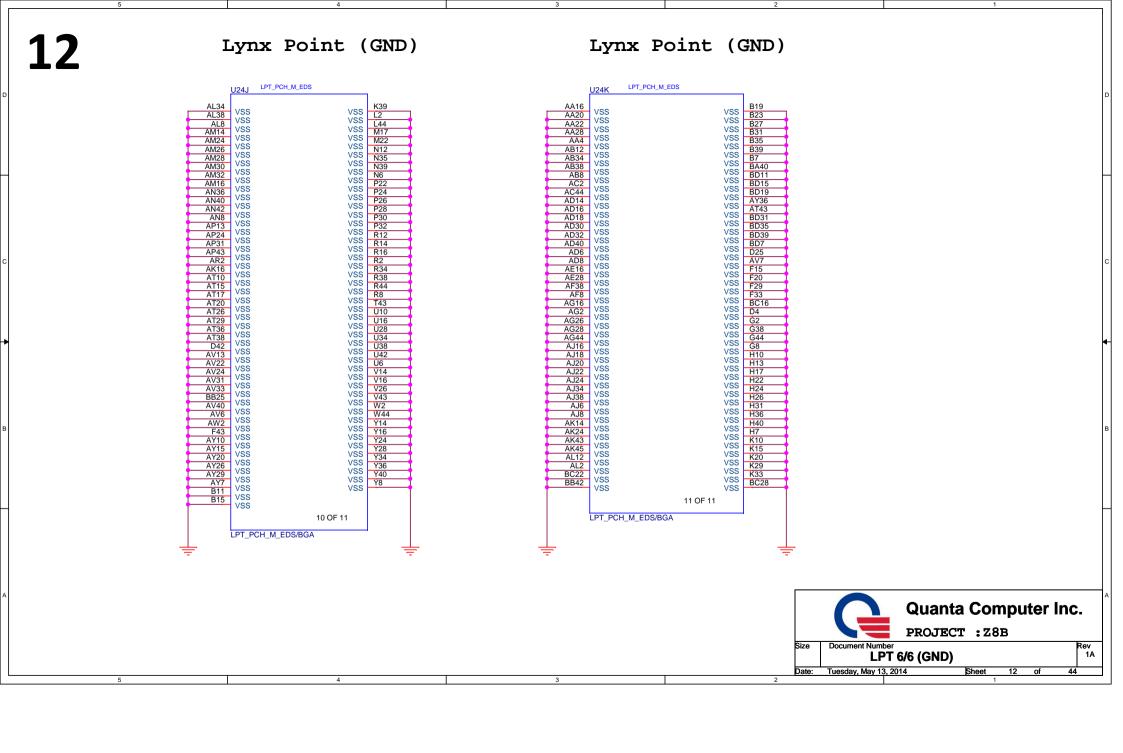


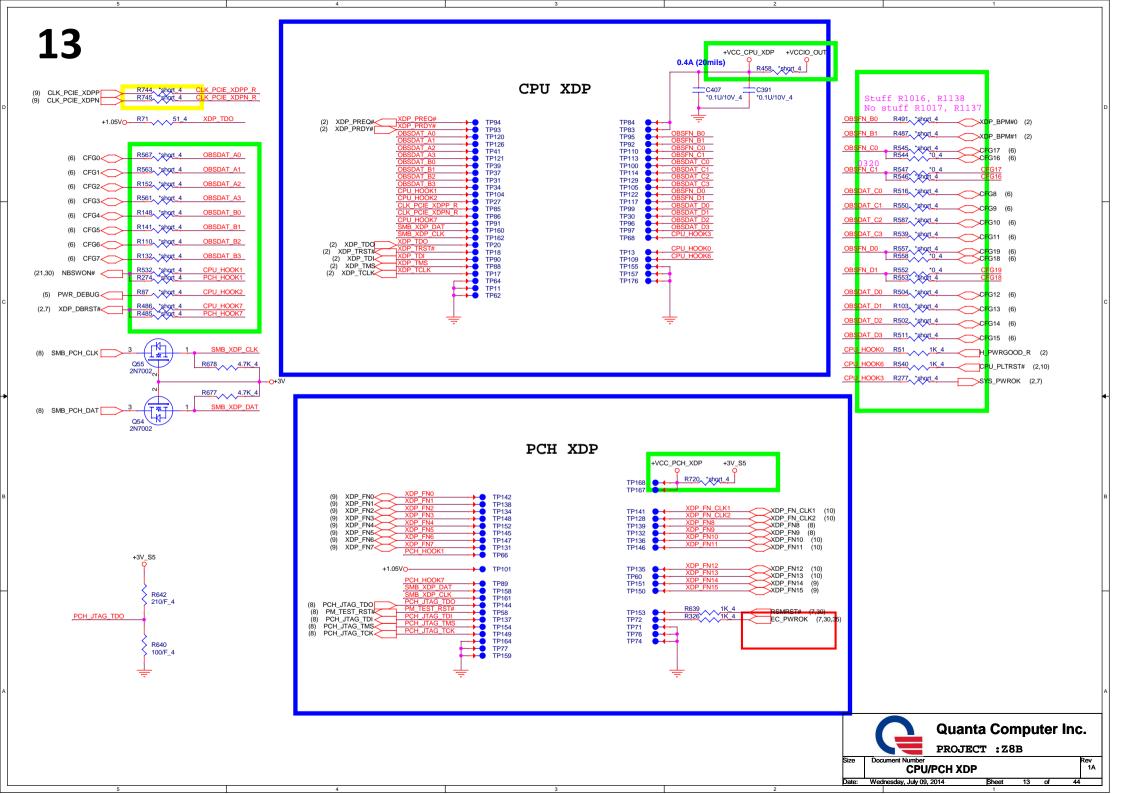


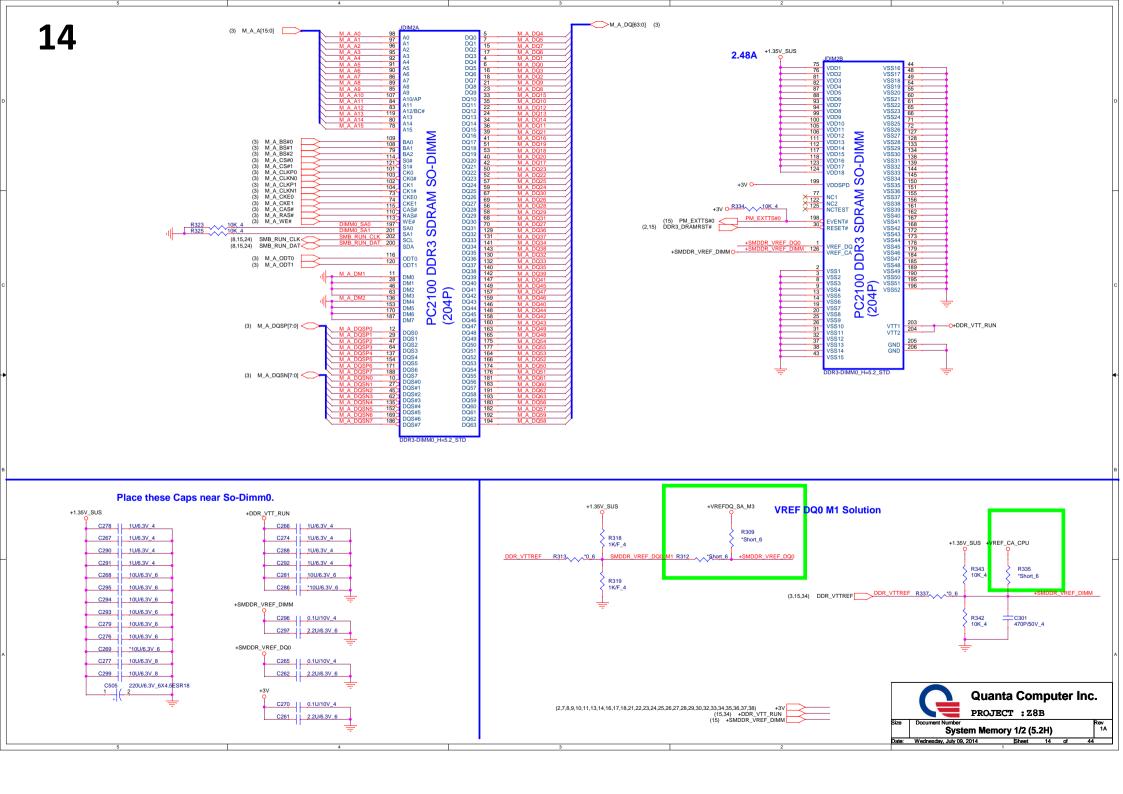


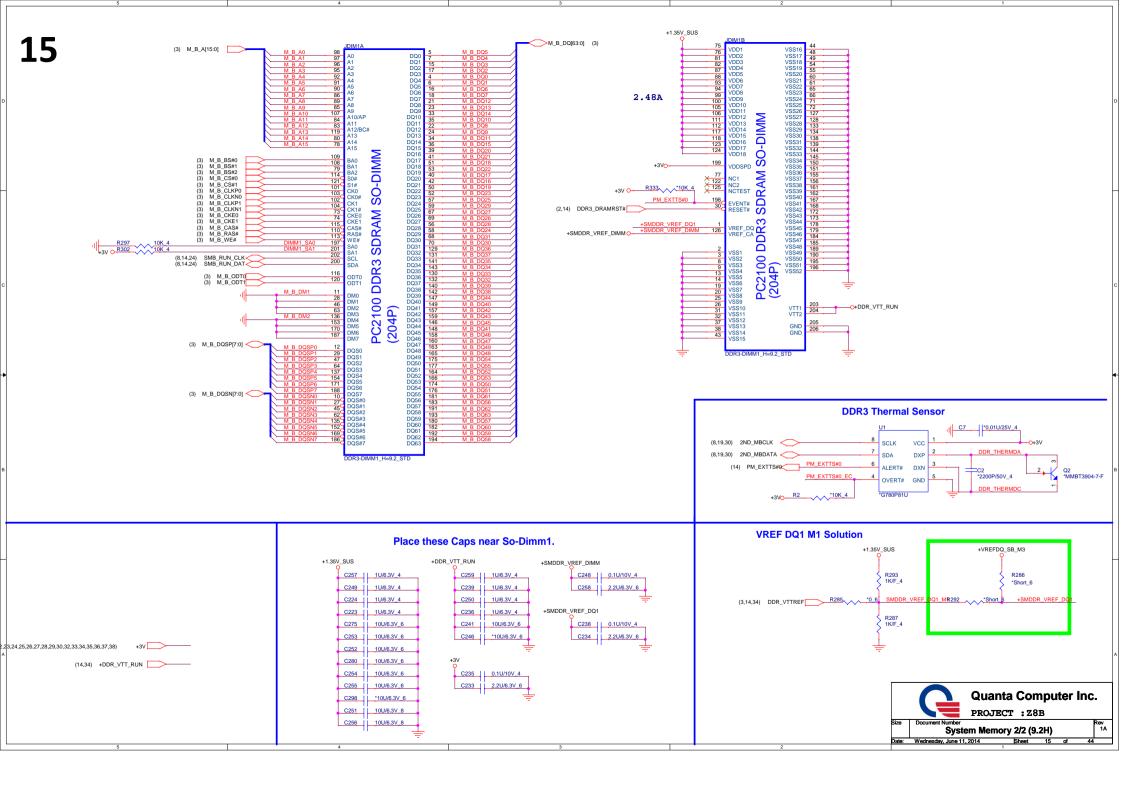


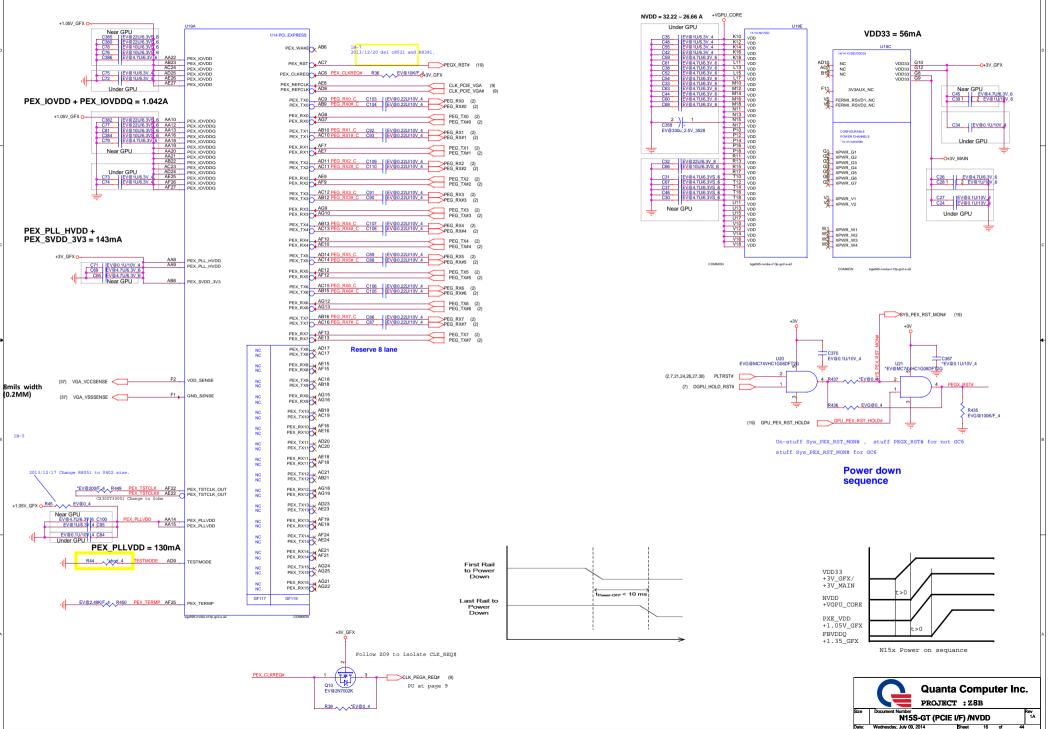


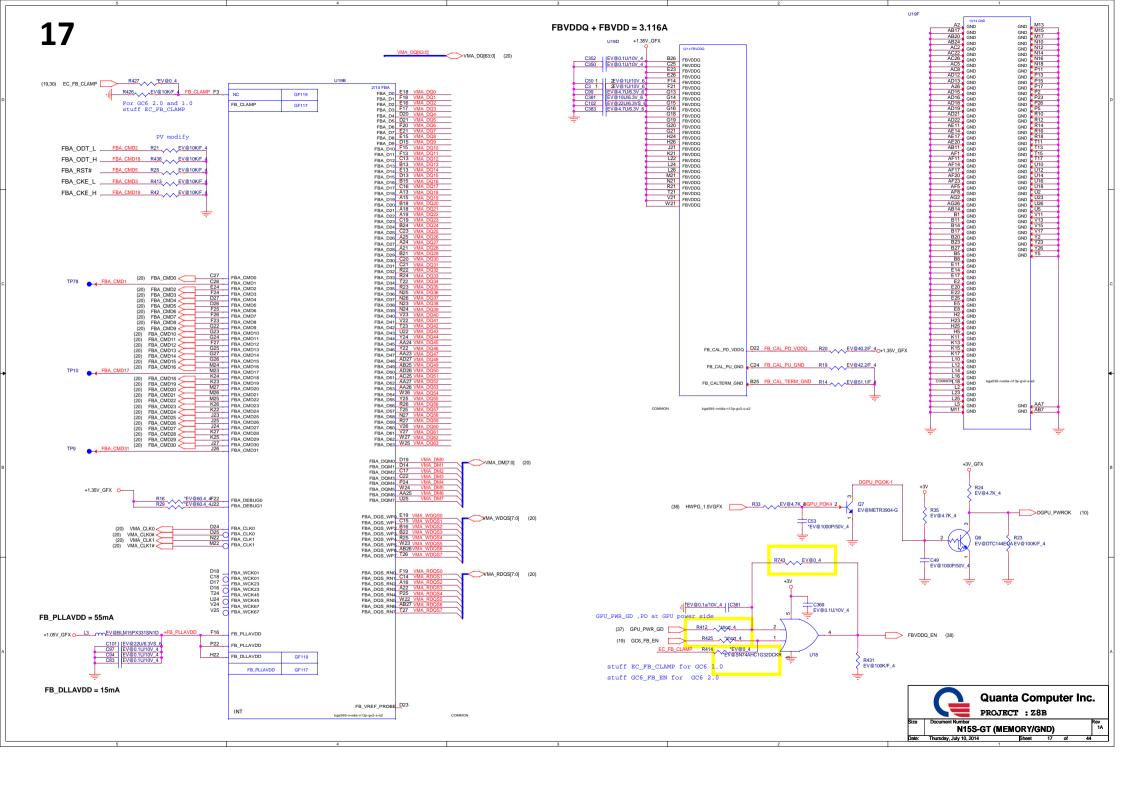


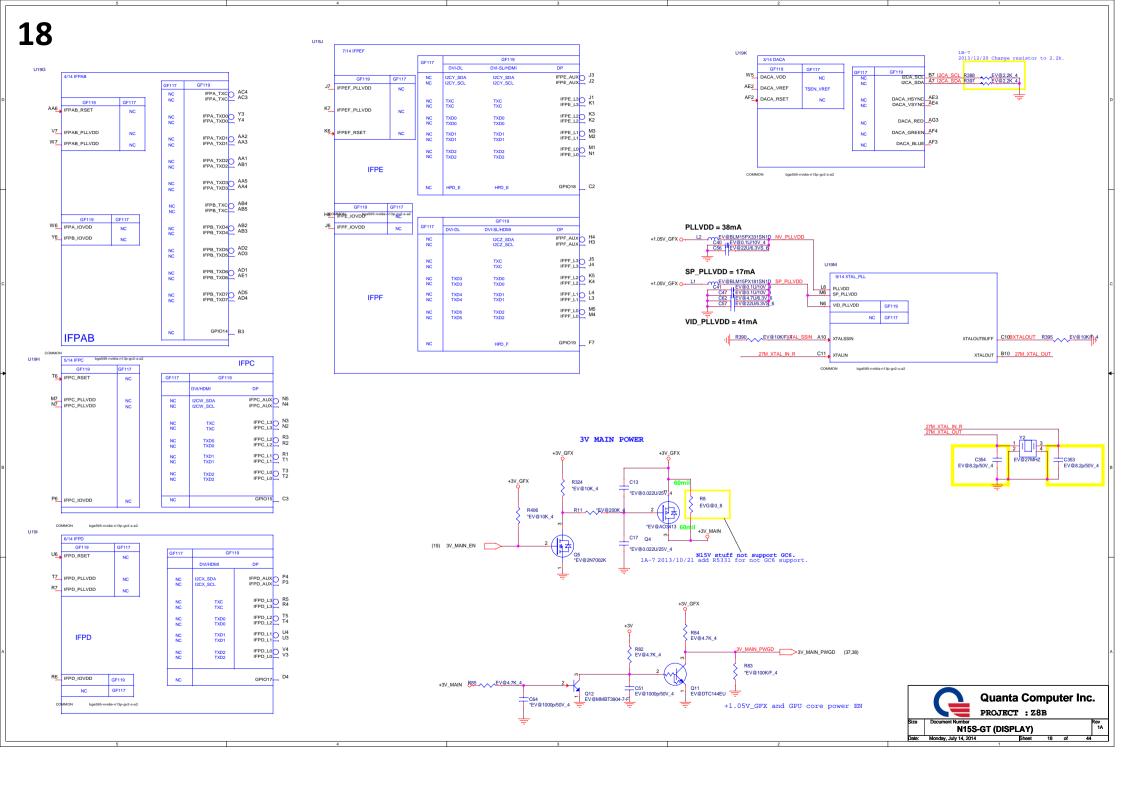


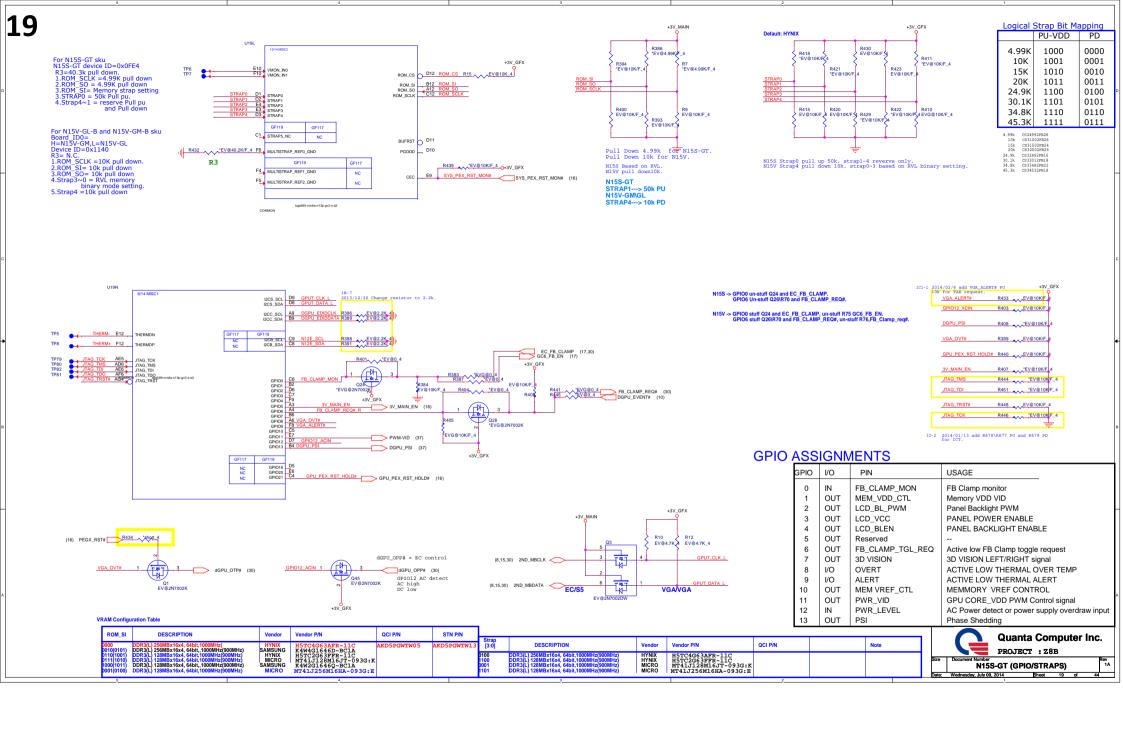


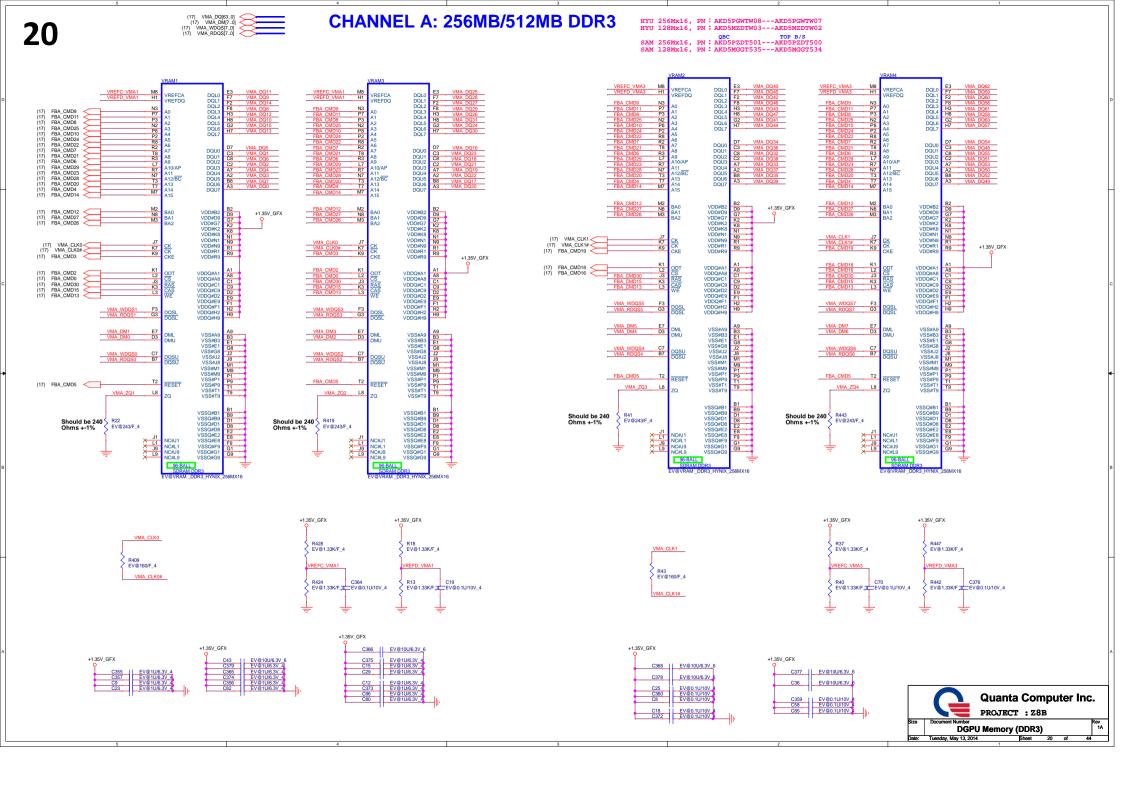




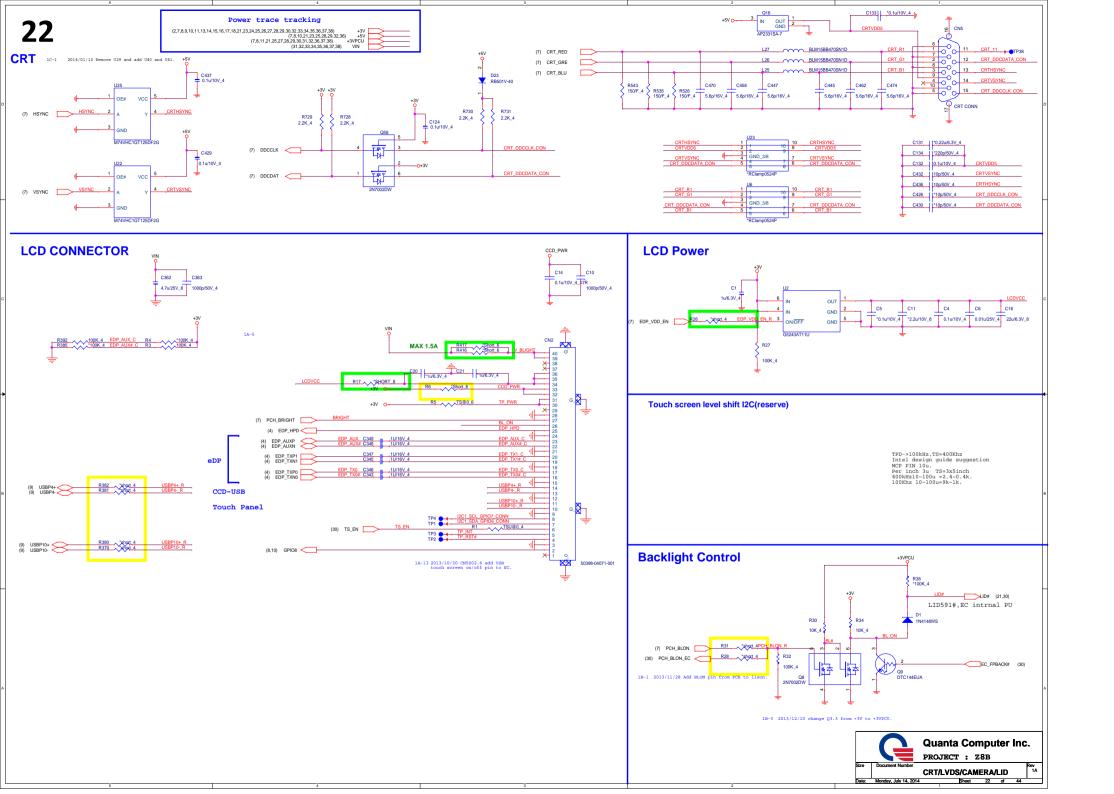


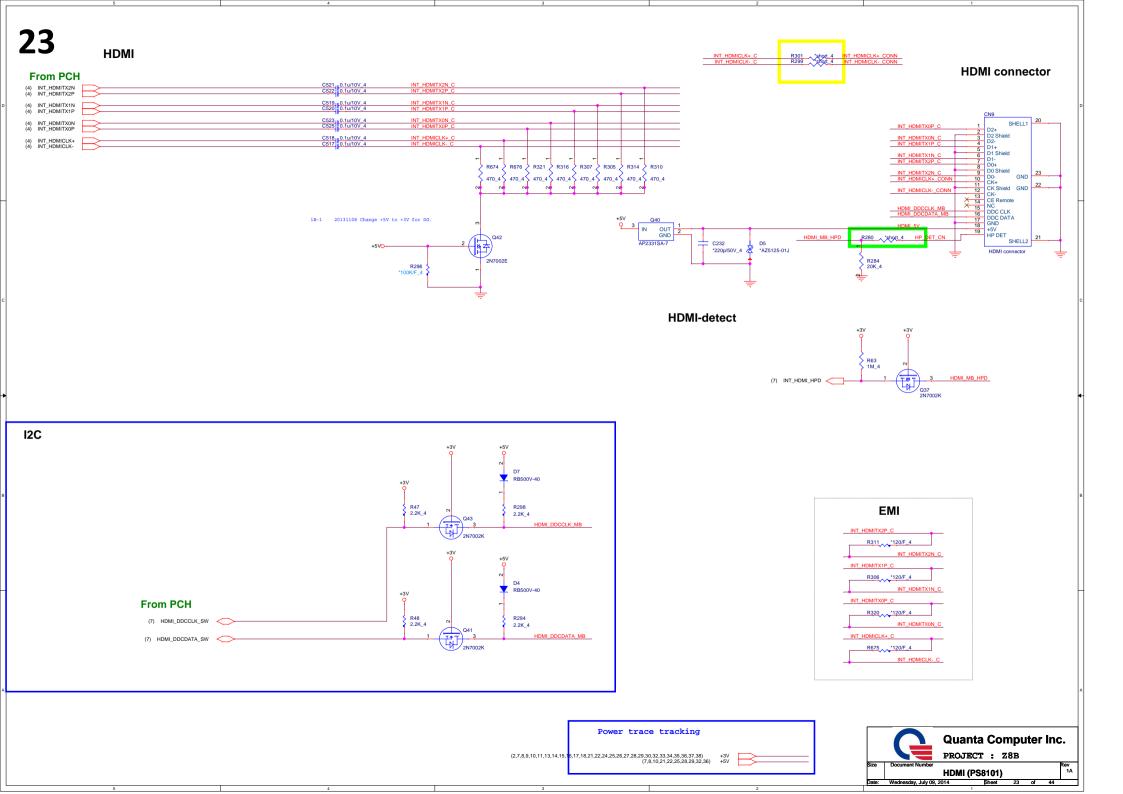


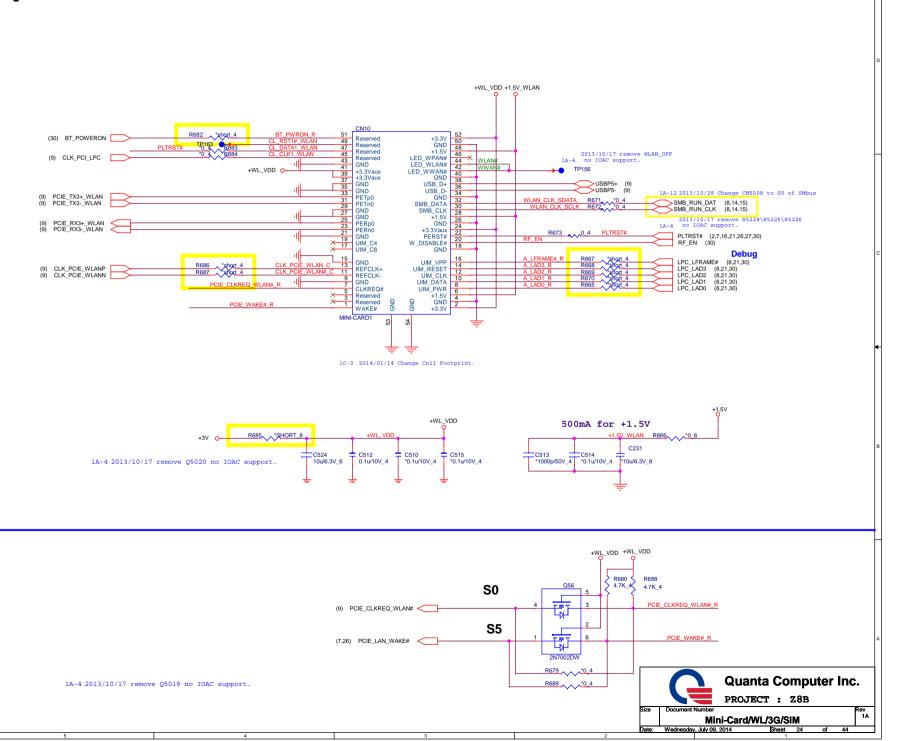


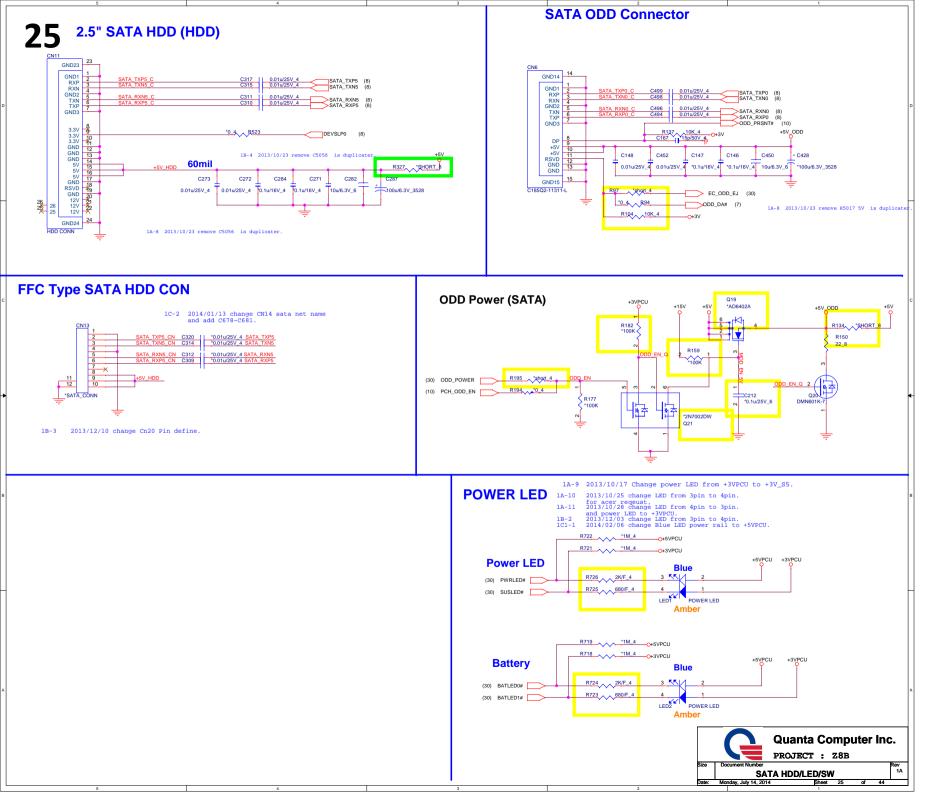


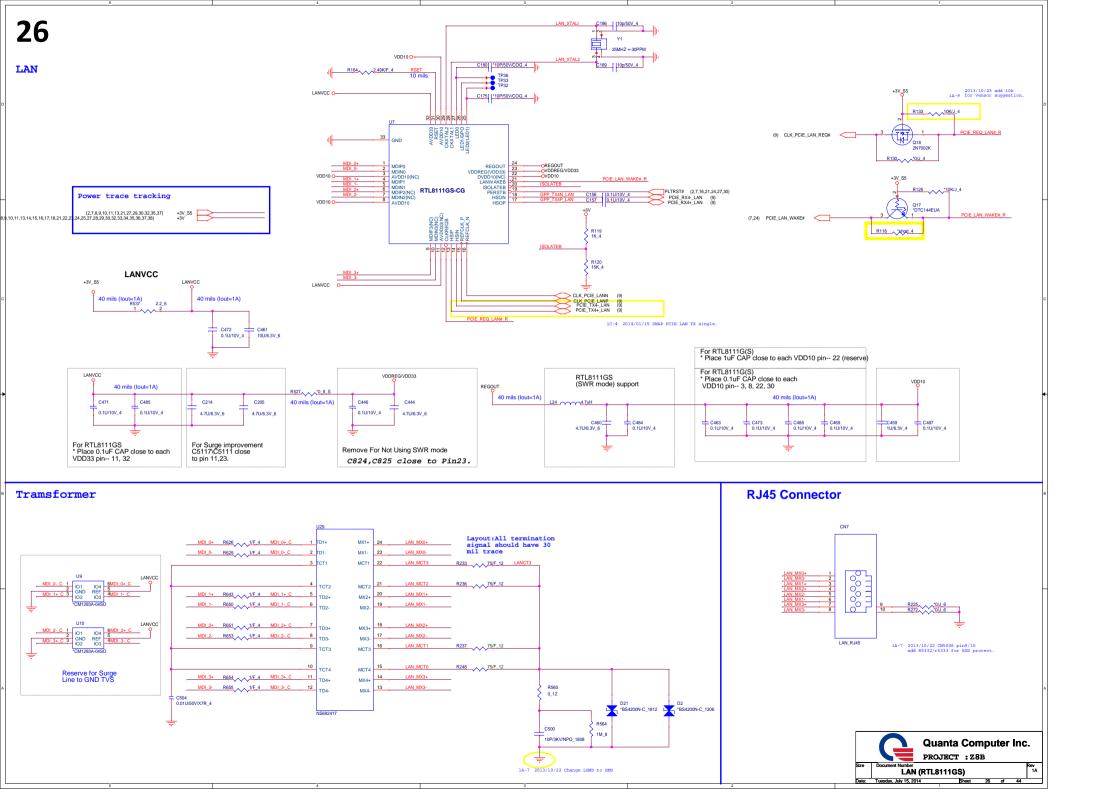
# DP TO VGA 1A-1 2013/10/15 Change VGA ITE soltion to NXP. 1A-5 2013/10/18 Change VGA NXP soltion to ITE. FingerPrint Conn 1B-6 2013/12/18 Change CN5 USB port to port2. Power Button/Conn 1A-1 2013/10/15 change to 6pin. 1B-2 2013/12/3 change to 4pin. 1B-3 2013/12/10 change CN6 footprint. **Green CLK Gen TPM** R250 TPM@0\_4 R262 TPMI@0\_4 +3V\_TPM\_VDD 1B-4 2013/12/13 remove Green GLK U9 TPMI@-->for SLB9655 TPMN@-->for Nuvoton R240 \*TPMI@0\_4 PLTRST#\_TPM TEST1 8 R249 TPM@10K\_4 stuff C503 stuff Un-stuff (2.7,16,24,26,27,30) PLTRST# (9.24,30) LPC FRAME# (8.30) RQ\_SERRO RT - RAMES | R R271 stuff Un-stuff R247 stuff Un-stuff R240 stuff Un-stuff +3V\_TPM\_VDD 2 1 R238 1PM@4.7K stuff Un-stuff 1A-11 2013/10/28 Change U5013.7 from +3V\_S5 to +3V. Quanta Computer Inc. PROJECT : Z8B ITE6513/TPM/FP/PB

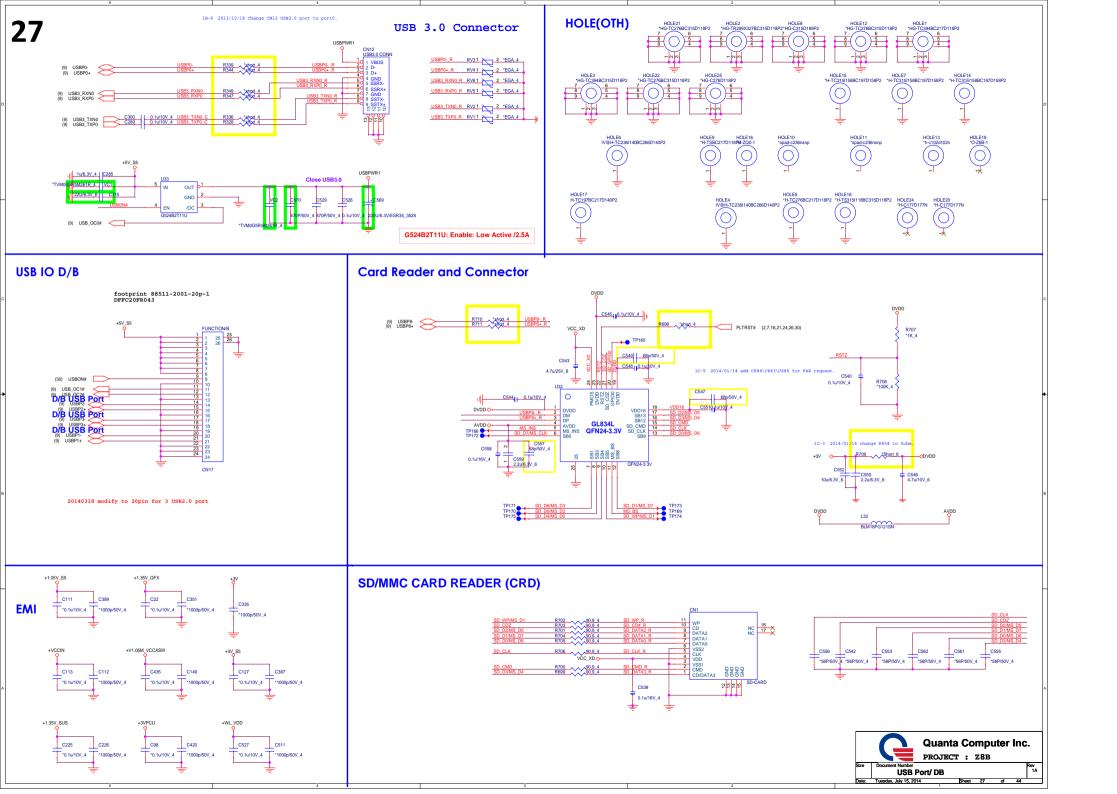


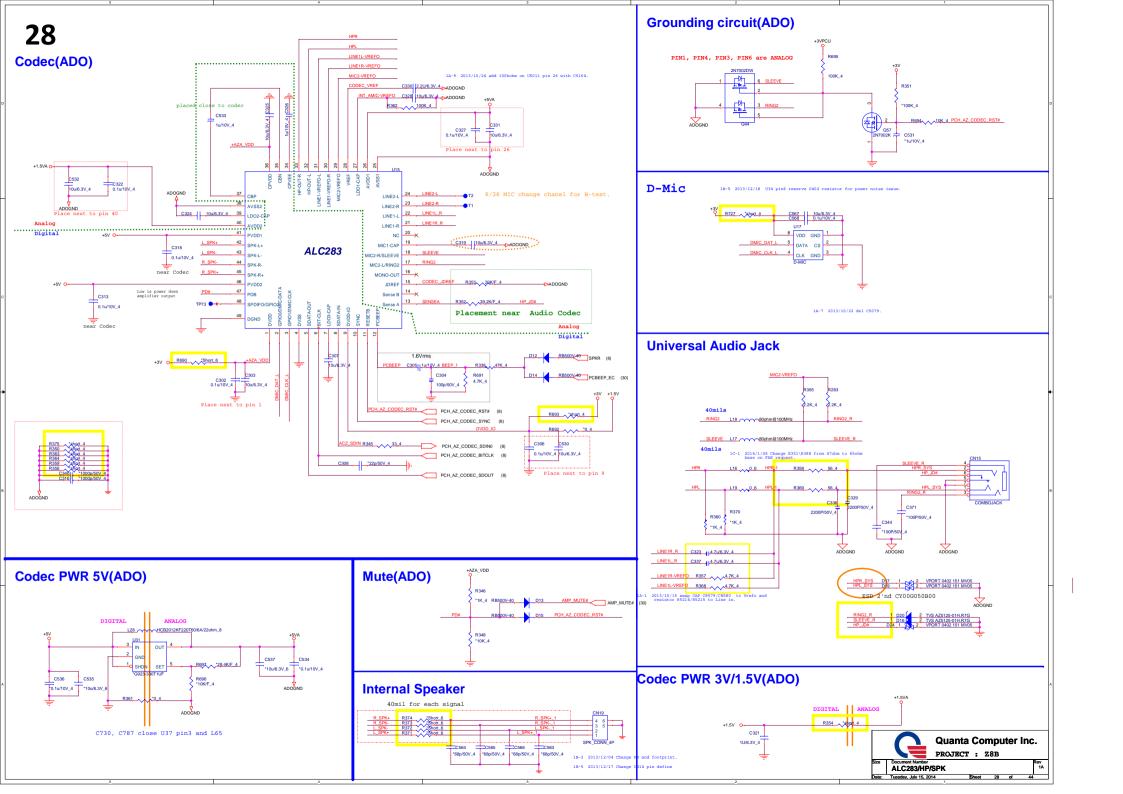


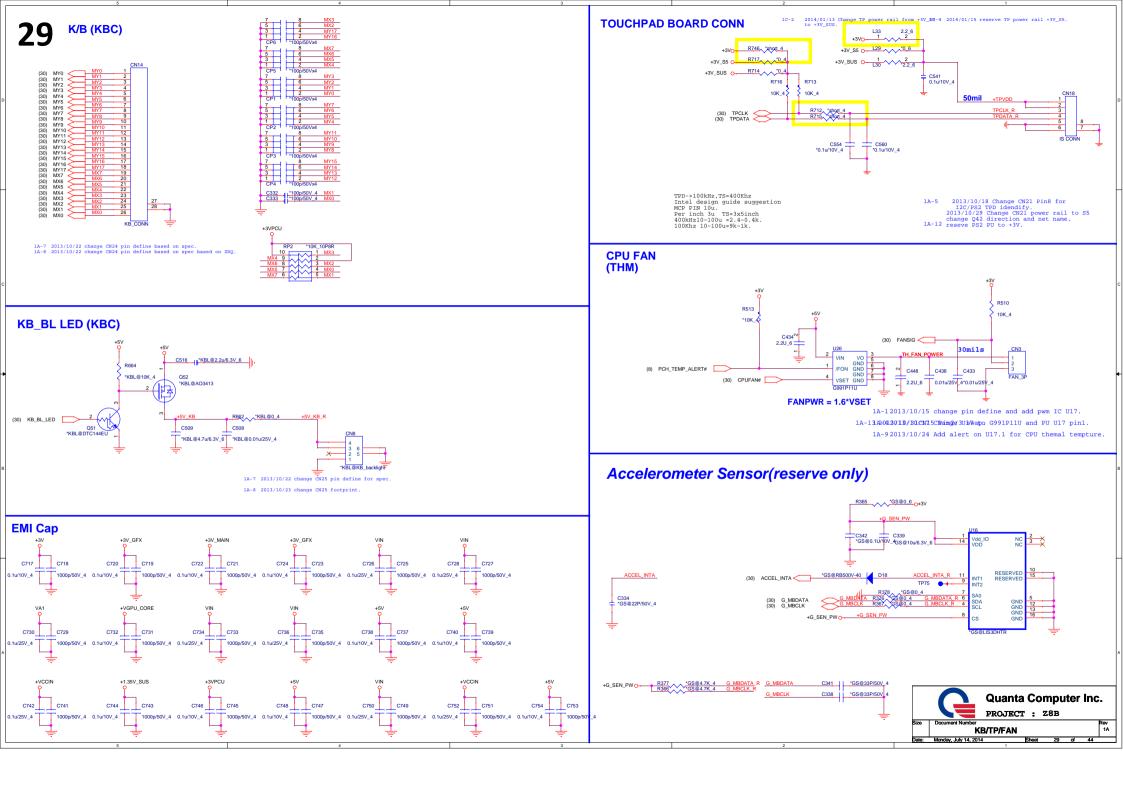


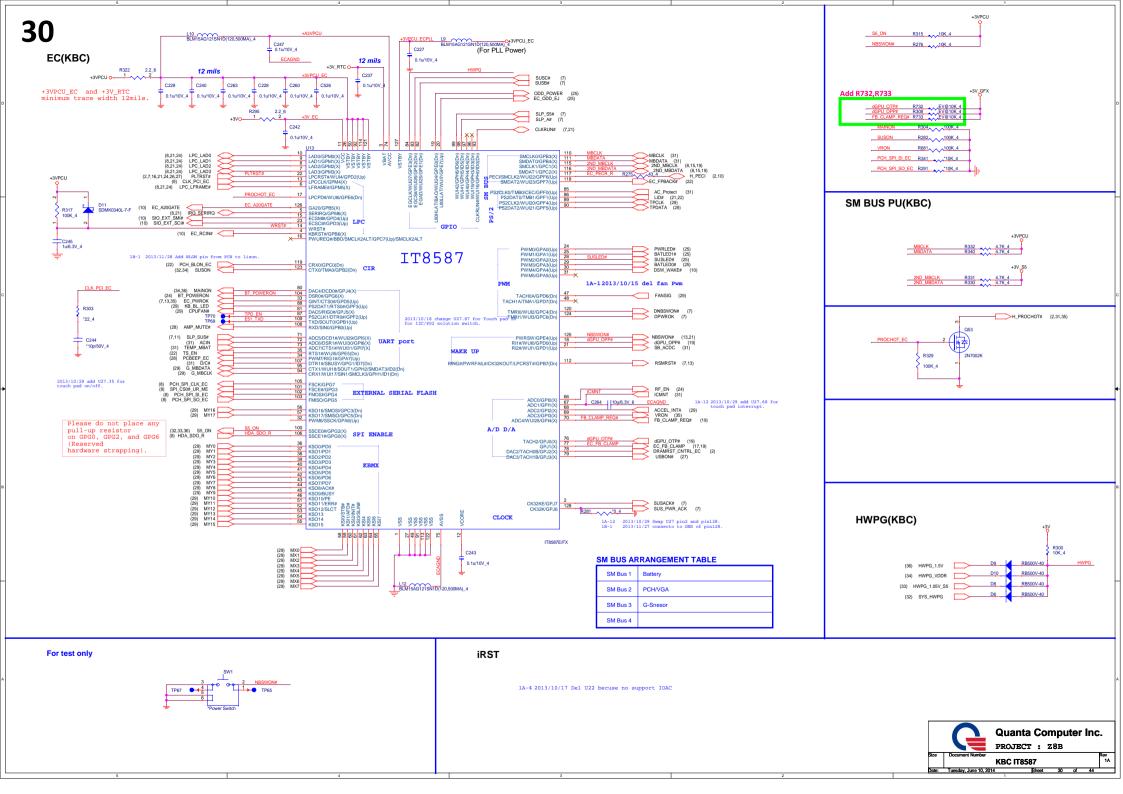


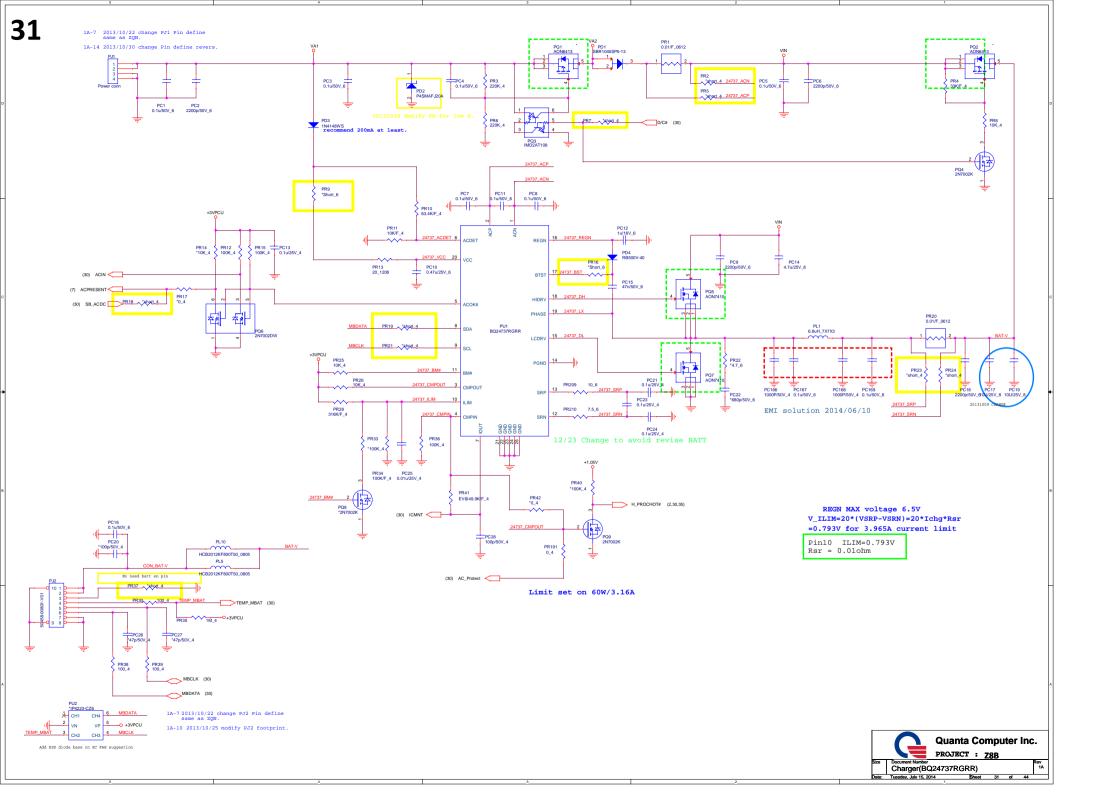


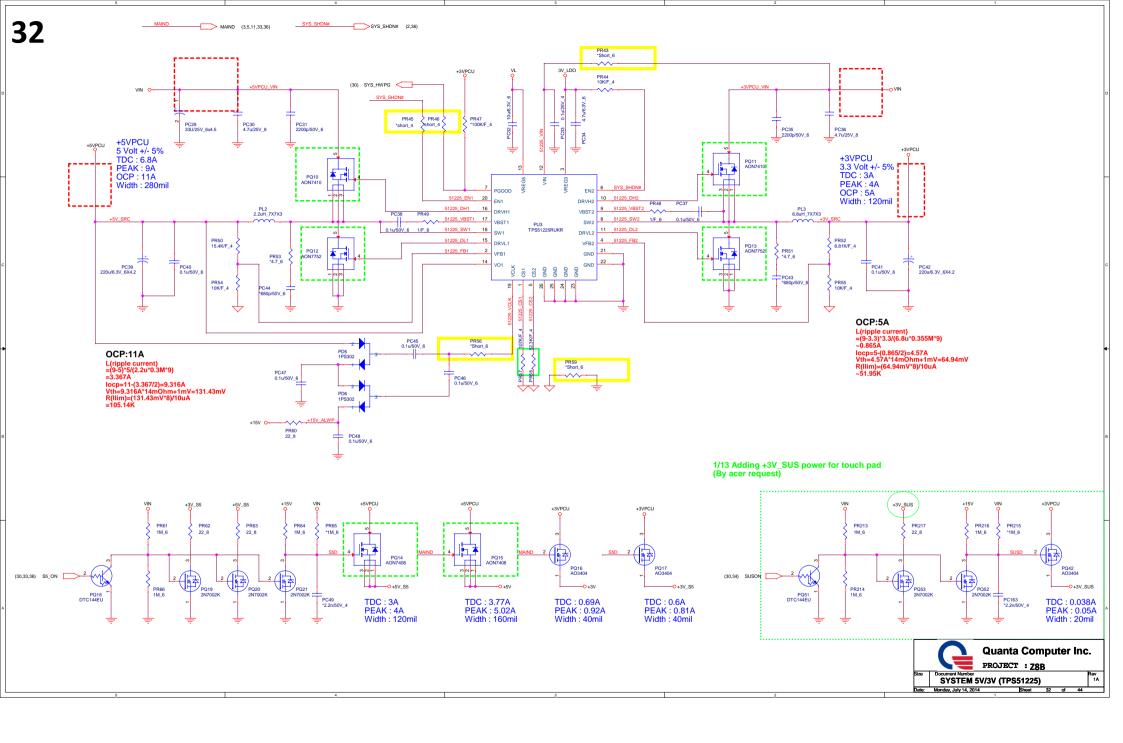


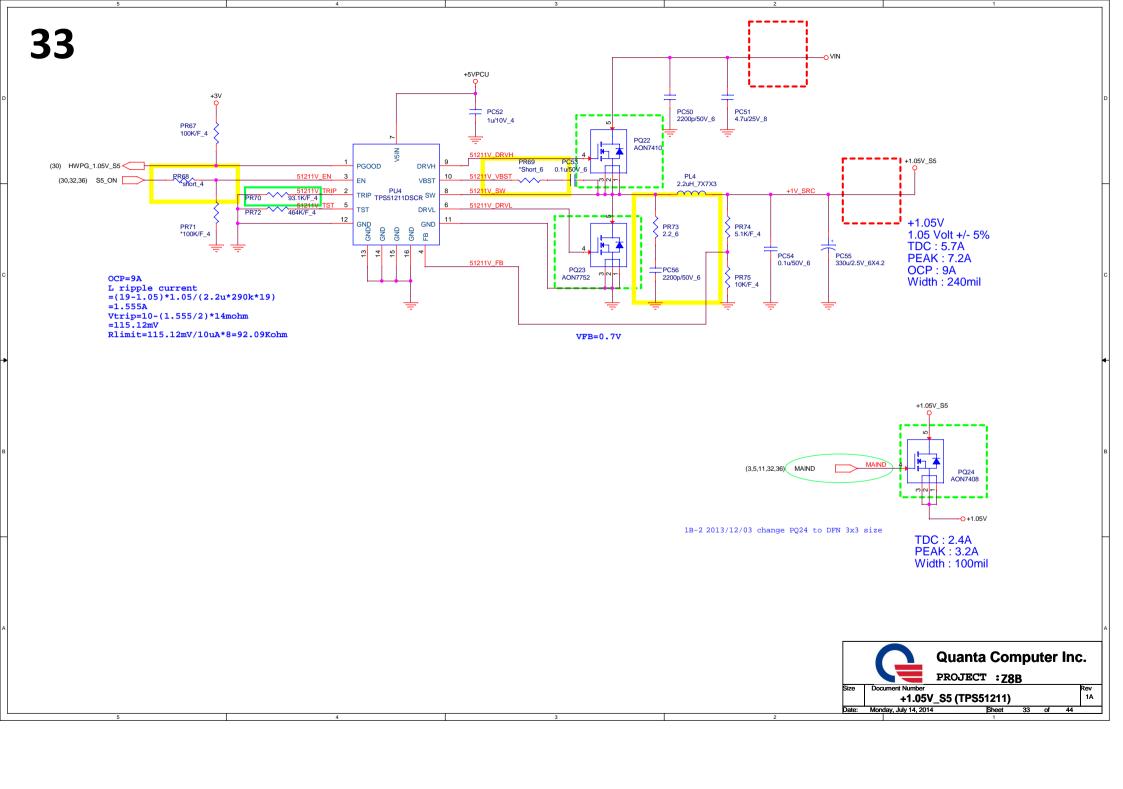


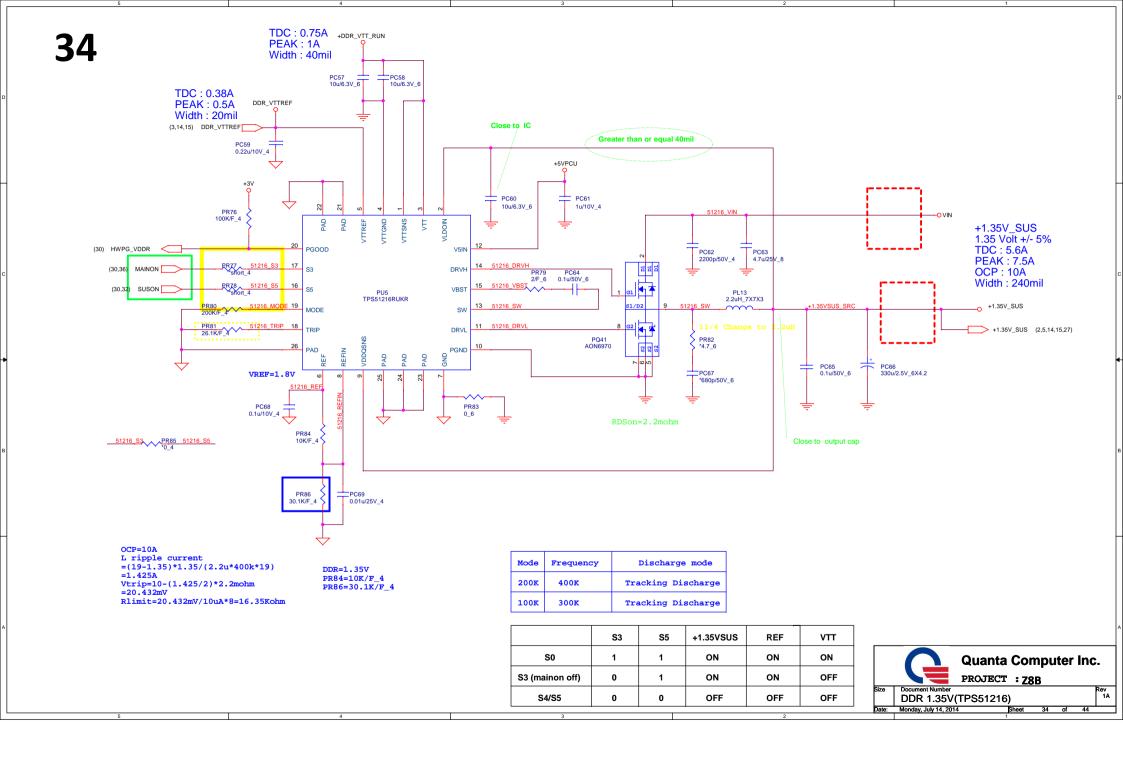


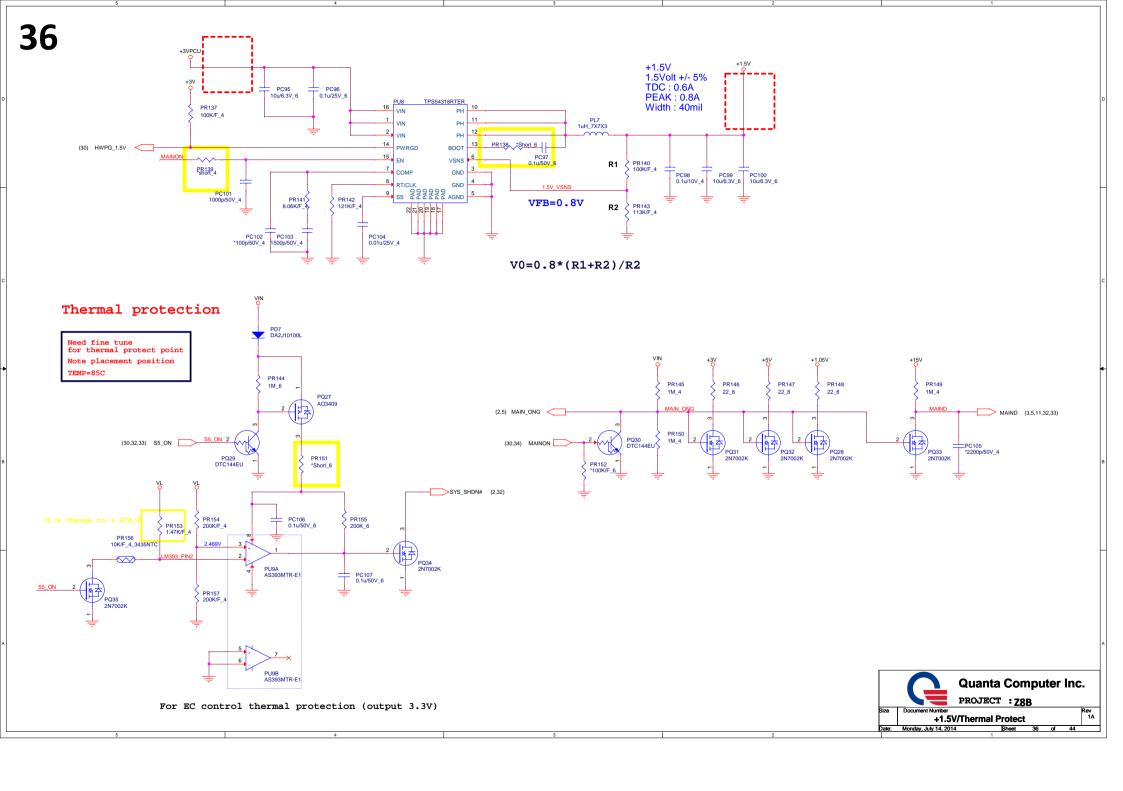


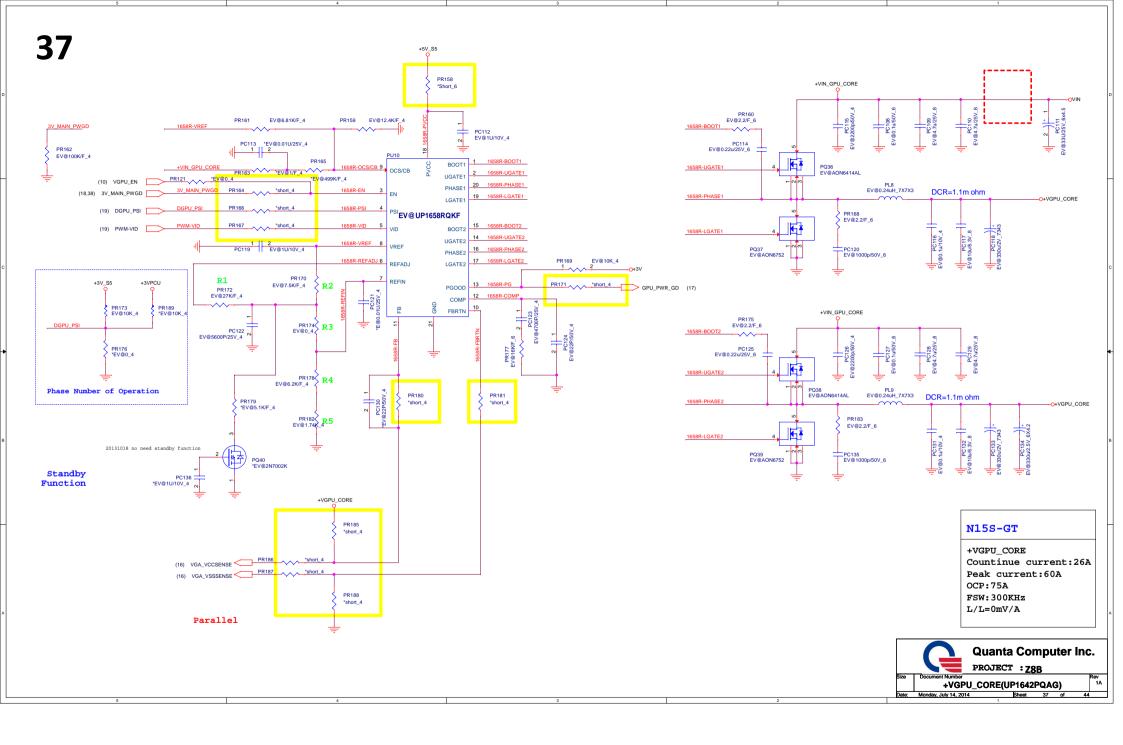


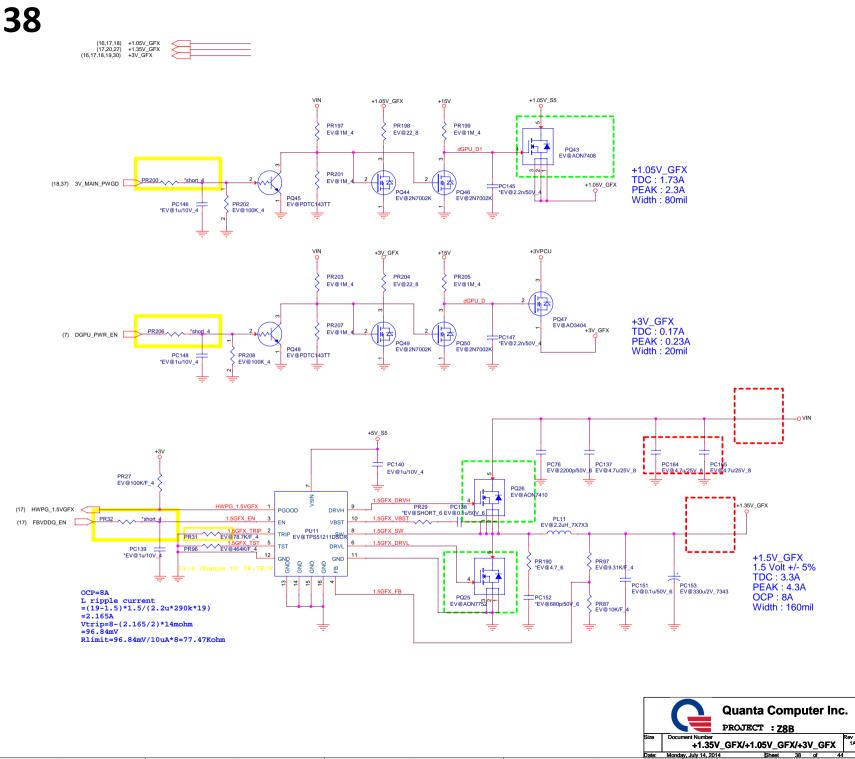




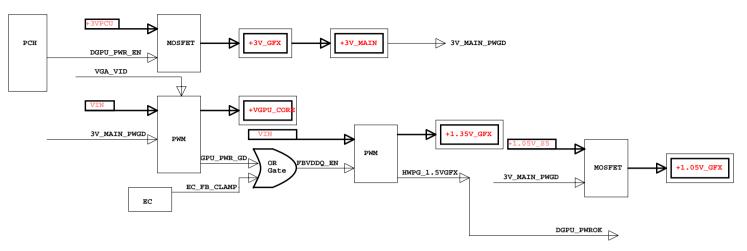




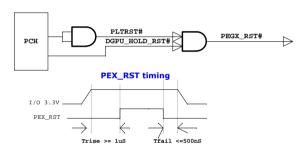




# 39 VGA power up sequence



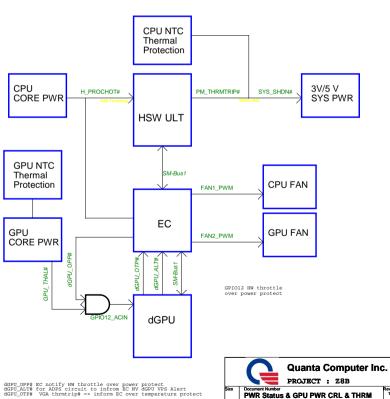
### VGA Reset



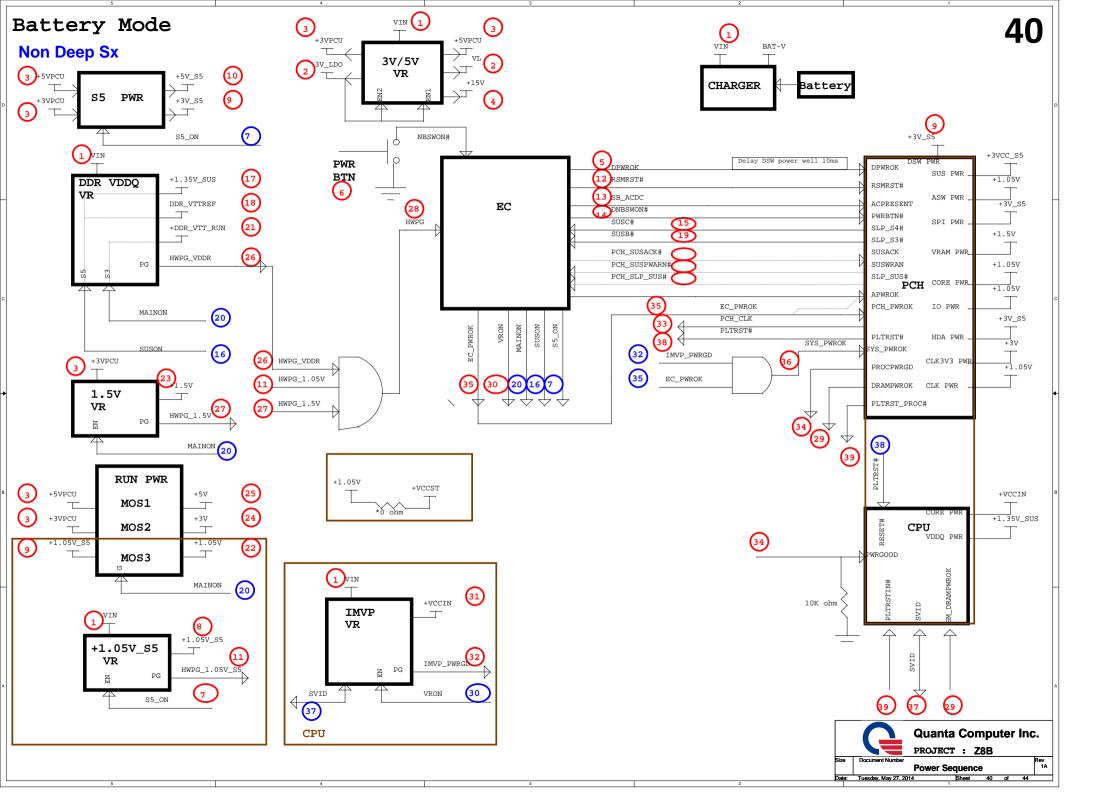
### **Power States**

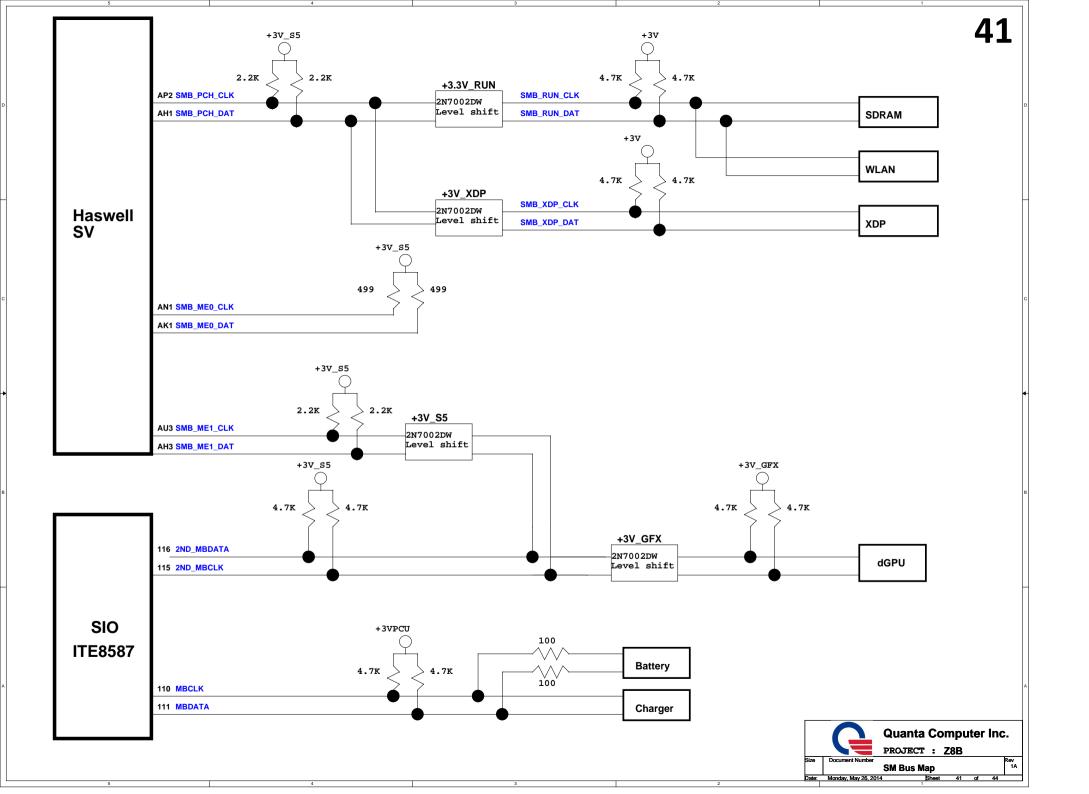
POWER PLANE	VOLTAGE	DESCRIPTION	CONTROL SIGNAL	ACTIVE IN
VIN	+10V~+19V	MAIN POWER	ALWAYS	ALWAYS
+3V_RTC	+3V~+3.3V	RTC POWER	ALWAYS	ALWAYS
+3VPCU	+3.3V	EC POWER	ALWAYS	ALWAYS
+5VPCU	+5V	USB CHARGE POWER	ALWAYS	ALWAYS
+15V	+15V	CHARGE PUMP POWER	ALWAYS	ALWAYS
+3V_S5	+3.3V	LAN	S5_ON	S0-S5
+5V_S5	+5V	USB POWER	S5_ON	S0-S5
+1.05V_S5	+1.05V	PCH CORE VCCST POWER& External GPU POWER	S5_ON	S0-S5
+5V	+5\2V	HDD/ODD/SPK/HDMI POWER/CRT	MAINON	S0
+3V		PCH/GPU/Peripheral component POWER	MAINON	S0
+1.35VSUS	+1.35V	CPU/SODIMM/MD POWER	SUSON	<b>S0</b> -S3
+DDR_VTT_RUN	+0.675V	SODIMM/MD Termination POWER	MAINON	
LCDVCC	+3.3V	LCD POWER	EDP_VDD_EN	S0
+1.5V	+1.5V	MINI CARD/NEW CARD POWER	MAINON	S0
+1.05V	+1.05V	PCH CORE VCCST POWER	MAINON	
+VCCIN	variation	CPU CORE POWER	VRON	S0
+VGPU_CORE	variation	External GPU POWER	VGPU_EN	
+3V_GFX	+3.3V	External GPU POWER	DGPU_PWR_EN	i S0
+1.35V_GFX	+1.5V	External GPU POWER	FBVDDQ_EN	
+1.05V_GFX	+1.05V	External GPU POWER	3V_MAIN_PWG	D S0

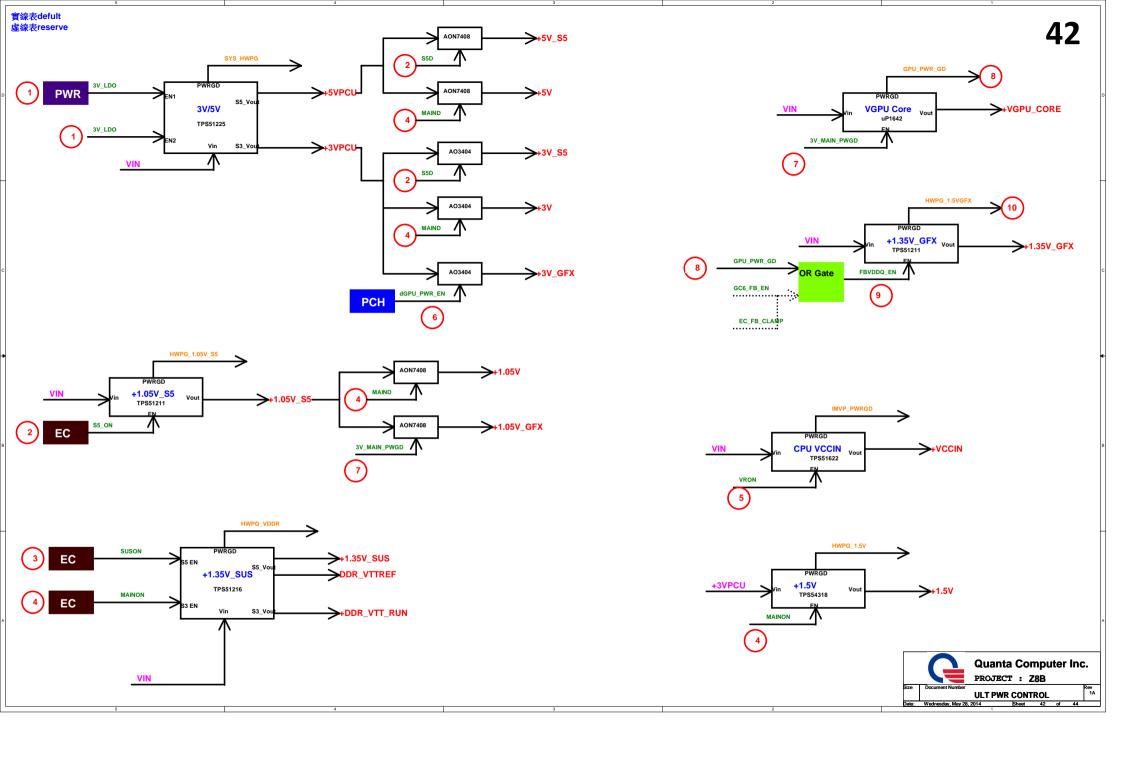
#### Thermal Follow Chart



dGPU\_OPP# EC notify HW throttle over power protect dGPU\_ALT# for ADPS circuit to infrom EC NV dGPU VPS Alert dGPU\_OTP# VGA thrmtrip# => inform EC over temperature protect







Model	Version	CHANGE LIST
EA41	1B-1	1 Stuff PR130 and PR134 (2014.05.30) -> Add Yover sensing Resistant
		2 Unstad PC156 and PC158 (2014 (26,30)->Remove Yeare PWM cap to balance 2 phase driving current 3 Staff R699 and R663 (2014 (6,5,0)->Change for EEPION QAID MODE
		4 Change R644 and R657 by CS21002[B34 (2014_05_30)->Change for EEPROM QAUD MODE
		5 Delete US, 144, C119 and Add (258, 8729, 8728, 8730, 8731, 823) (2014. 96, 99) Change for CRT CCD level shift  6. Change Y3 from BG625900737 to BG625900081 (2014. 96, 99) Change for Parts 1000 issue
		7 Change R255 change L28K to L8K(2014, 06,09)->-Change for Perts EOD losses
		8 Change C109/C310/C311/C312/C315/C315/C315/C315/C315/C315/C315/C315
		10 Add JE (2014_06_10)
		11 United (033 (2014, 66, 10) ->Cost saving 12 mtd (2010 (2014, 66, 10) ->colving Discrete issue
		13 Add R732,R733 (2014,96,10) Observete issue
		14 Delice U14,2283 Add U13,539,62579 Add Lacation VC1,VC2,C15,C570,C59(2014, 16, 10)Solving ISB droup issue  15 Change R500,R50,R123,R256,R257,R192,R191,R455,R88,R93,R334,R534,R531,R617,R625,R644,R200,R470,R213,R212,R548,R382,R382,R3823,R623,R391,R658,R183,R2214 from Res 0 obtain 9402 to short padCest saving
		16 Delete RP4,RP5,RP6 Add Location R734,R735,R736,R737,R738,R739 ->-Cost Saving
		17 Delete RS22,RS30Cost saving 18 Change
		18 Changer 61/22669/2364/1365/2365/22171.8650/8571.8651/8651/8659/23669/23659/23669/8651/8659/23669/8659/23669/8659/23669/8659/23669/8659/23669/8659/8659/8659/8659/8659/8659/8659/8
		20 Change B488,R54,R190,R64,RS3,R62from Res 0 ohom 0805 to short pad(2014,06,11)
		21 Add PC166/PC167/PC160/PC160 for EMI solution 22 Dolese [P11]P12_P15_P16_P14_P10_P7_P14_P5_P17_P16_P16_P16_111
		23 Change PR 192 from CS22742FB00 RES CHIP 2.74K 1/16W +1%(0402) to CS22492FB22 RES CHIP 2.49K 1/16W +1%(0402) (2014.06.11) -> Power require
		24 Change PR129 from CS410927812 RES CHIP 1/9/K 1/16/W +1%(0402)to CS41592FB18 RES CHIP 150K 1/16/W +1%(0402) (2014_06_11)Prover require 25 Add PC164_PC165[2014_06_11]
		26 Change 8171 from CSE1992[810 to CSE1992[800]0244_96_11]
		27 Change PC7 from CH43302RE14 to CH472X9000 (2014.06, 11) 28 Change CN19 from DPHD-04MR153 to DPHD-04MR256 for SNT issue(2014.06, 11)
		29 Change CN16 from DFFC04FR05Ft to DFFC04FR127 by ME request(2014,06,11) 3g Change CN17 from DFFC24FR043 to DFFC24FR039 by ME request(2014,06,11)
		31 Stuff C503(2014.96.12)
		32 Unstaff R262 Staff R259(2014, 66, 12) 33 Staff R264(2014, 66, 12)
		34 Stoff R271(2014, 96, 12)
		35 UnSoulf R247(2014_06_12) 36 Change Ullfrom ALDOWSSSR01 to ALDOWSSSR00(2014_06_12)
		37 United R69.2864(2014.06,12)
		38 Delete R181 Add R522(2014, 66, 12) 39 Delete ReleC23(2014, 66, 12)
		40 OncodIII NY J.NY J.NY J.NY J.NY J.NY J.NY J.NY J
		41 Biole-Minlet change from the TC1631140BC236D140P2 to th TC2361140BC276D140P2(2014.06.12) 42 Dinniell R271 (2014.06.12)
		43 Unstaff L11 and stuff 1001, 8299(2014,06,12) 44 Unstaff L31 and stuff 8798, 8731(2014,06,12)
		45 Change R26,R280from Res O shom 0402 to short pad(2014,06,12)
		46 Change R416,R417,R6 from Rev O chosen 0603 to shore pad(2014, 06,12) 47 Change R17,R227 from Rev O chosen 0605 to shore pad(2014, 06,12)
		48 Change U32 from AL000834003 to AL000834004(20140613)>5D Card issue
		49 Change C417,C418 from C001000(8097(CAP CHP 18P SW(+-5%, CNG 6402)) to CH01006(800(CAP CHP 10P SW(+-5%, CNG,0402)))(2014,06,13)—>Y3 EDD issue  50 Change 14 from C0000181016 to CCSPE10100(20140615)—>EDD issue
		\$1 Change DZ2 from BCRNT54C294 to BCRNT54C213(20140613)NDD Insue
		\$2 Champy C2B, Q4B,Q50 from BA001440287 on BA0014400812(0140613) >> E0D issue \$3 Champy 01,Q14,Q22,Q23,Q24,Q24,Q24,Q24,Q24,Q55, from BAMT0020002(20140613) >> E0D issue
		\$4 Obango 94,07 from BCBB509VZ25(20146613)->>100 issee
	1C-1	1 Add thermal-trip schematic Add Location U3,(290,(46),(716,8744,8744,8744(20140701)) 2 Delete PJP1 for Assembly issus(20140701)
		3 Add E743 for cost down[20140701] 4 Add E7417,71478,[F149],[F140 for SMT tost[20140701]
		5 Add TP181 for SMT test[20140701)
		6 AM C11/C18,C19/C19/C12/C12/C12/C12/C13/C14,C13/C13/C13/C13/C13/C13/C13/C13/C13/C13/
		8 Add PR36 CS41002JB20 RES CHIP 100K 1/16W 5%(0402) (20140704)
		9 AAA PRZA C331002[RZB RES CHIP 10K 1/16W 5/4(0402) (20140704)  10 AAD PRJ91 C30002[RZB RESSTOR CHIP 0 1/16W +5/4(0402) (20140704)
		11 Add PQP BAM70020002 "TRANSISTOR MOS 2X7002X(60V,300MA)SOT-23 (201-00704)
		12 PC3/PCT3/PC11 change from CG5330M202 to CG5330M203 for material prepare issue 13 CZ2/PC2/PC03 change from CH6221M3002 to CH6221M300 for material prepare issue
		14 Change NeV9,2202,844,8412,8425,8424,8229,2273,856,8228,131,8662,8666,8667,8665,8667,8668,8668
		16 Change RTS,R101,R512,R142,R61,R477,R685 from Res O shom 0005 to short pad
		17 Delete PR3 Add 8744,8745 18 Delete 121,120
		18 Online 12.1.28 Change RET9-8300,8281-81822 from BES of shim 6442 to short pad(2014-97-99) 19 Online 11.0 Change RET9-8300 from BES of shim 6462 to short pad(2014-97-99) Change RET9-8201 from BES of shim 6462 to short pad(2014-97-99)
		20 Okoke 111 Change R290, R301 from RES 0 ohm 0-02 to short pad(2014-07-09) 21 Okoke 1314415
		2) Debtor LLIALALIA Change REVINS-HAR-RAY-RAY-RAY-RAY-RAY-RAY-RAY-RAY-RAY-R
		11 Institut 11.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1.1
		2.5 Souff R742 and un stuff U18 (2014_07_09)
		26 Change Kinder Standprint from N-TSK217011897 to N-286-1 (2014-07.11) 27 Change CRI foragrint from subserle-guided-Orginism-MO-11sp to science-5-2150001000-6-11p sent(2014-07.11)
		28 Change 17:022 Codyrint from 179:075 to 17:0250 (2014, 67, 21) 39 Change Net: 92101E, 8, 87042, 8 connection from ACCORD to LORAD (2014, 67, 21)
		36 Add Net IPF_IDW connection to DDND [DD14_07_12]
		3) United E10 and RTA, U.S. and RTAG connect to +SW (2014, 67, 22) 32 Add M9218 (2014, 67, 22)
		33 Add Location PCITO (1814_09_14)
		34 Change CES, CESA Horm CAP CHIP 129 500 to CAP CHIP 129 500 (120 A 07), AS 35 Unstalf (221, 1815, 025, CES, 1815 025, CES, CES, CES, CES, CES, CES, CES, CES
		3g. Add P114 and P115 for reducing Vin noise [1014, 507, 41]
		37 Chapp PELIA from RES COPP o about 0505 to about pad (DELA OF _14)  NG Chapp PELIA from RES COPP o about 0505 to about pad (DELA OF _14)  NG Chapp PELIA from RES COPP o about 0505 to about pad (DELA OF _14)  NG Chapp PELIA from RES COPP o about 0505 to about pad (DELA OF _14)  NG Chapp PELIA from RES COPP o about 0505 to about pad (DELA OF _14)  NG Chapp PELIA from RES COPP o about 0505 to about pad (DELA OF _14)  NG Chapp PELIA from RES COPP o about 0505 to about pad (DELA OF _14)  NG Chapp PELIA from RES COPP o about 0505 to about pad (DELA OF _14)  NG Chapp PELIA from RES COPP o about 0505 to about pad (DELA OF _14)  NG Chapp PELIA from RES COPP o about 0505 to about pad (DELA OF _14)  NG Chapp PELIA from RES COPP o about 0505 to about pad (DELA OF _14)  NG Chapp PELIA from RES COPP o about 0505 to about pad (DELA OF _14)  NG ChapP PELIA from RES COPP o about 0505 to about pad (DELA OF _14)  NG ChapP PELIA from RES COPP o about 0505 to
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